

September 2009

H11G1M, H11G2M, H11G3M — High Voltage Photodarlington Optocouplers

# H11G1M, H11G2M, H11G3M **High Voltage Photodarlington Optocouplers**

### **Features**

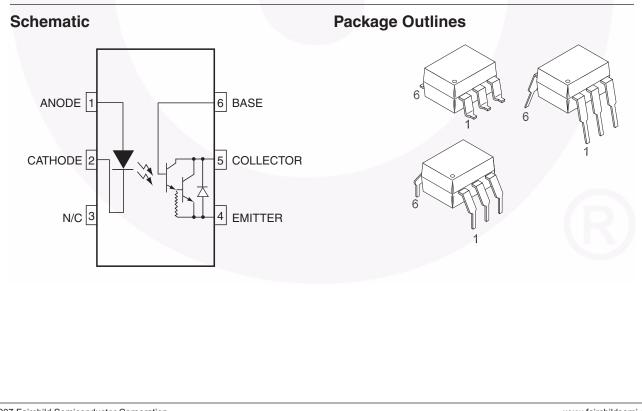
- High BV<sub>CEO</sub>
  - Minimum 100V for H11G1M
  - Minimum 80V for H11G2M
  - Minimum 55V for H11G3M
- High sensitivity to low input current (Min. 500% CTR at  $I_F = 1mA$ )
- Low leakage current at elevated temperature (Max. 100µA at 80°C)
- Underwriters Laboratory (UL) recognized File # E90700, Volume 2
- IEC 60747-5-2 approved (ordering option V)

### Applications

- CMOS logic interface
- Telephone ring detector
- Low input TTL interface
- Power supply isolation
- Replace pulse transformer

## **General Description**

The H11GXM series are photodarlington-type optically coupled optocouplers. These devices have a gallium arsenide infrared emitting diode coupled with a silicon darlington connected phototransistor which has an integral base-emitter resistor to optimize elevated temperature characteristics.



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## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
TOTAL DEVIC	E		
T <sub>STG</sub>	Storage Temperature	-40 to +150	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
T <sub>SOL</sub>	Lead Solder Temperature (Wave Solder)	260 for 10 sec	°C
PD	Total Device Power Dissipation @ $T_A = 25^{\circ}C$	260	mW
	Derate Above 25°C	3.5	mW/°C
EMITTER			
۱ <sub>F</sub>	Forward Input Current	60	mA
V <sub>R</sub>	Reverse Input Voltage	6.0	V
l <sub>F</sub> (pk)	Forward Current – Peak (1µs pulse, 300pps)	3.0	А
PD	LED Power Dissipation @ $T_A = 25^{\circ}C$	100	mW
	Derate Above 25°C	1.8	mW/°C
DETECTOR	· · · · · · · · · · · · · · · · · · ·		
V <sub>CEO</sub>	Collector-Emitter Voltage		
	H11G1M	100	V
	H11G2M	80	
	H11G3M	55	
PD	Photodetector Power Dissipation @ $T_A = 25^{\circ}C$	200	mW
	Derate Above 25°C	2.67	mW/°C

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### Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise specified.)

### Individual Component Characteristics

Symbol	Characteristic	Test Conditions	Device	Min.	Тур.*	Max.	Unit	
EMITTER				-1		1		
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 10mA	All		1.3	1.50	V	
$\frac{\Delta V_{F}}{\Delta T_{A}}$	Forward Voltage Temp. Coefficient		All		-1.8		mV/°C	
BV <sub>R</sub>	Reverse Breakdown Voltage	I <sub>R</sub> = 10μA	All	3.0	25		V	
CJ	Junction Capacitance	V <sub>F</sub> = 0V, f = 1MHz	All		50		pF	
		V <sub>F</sub> = 1V, f = 1MHz			65			
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> = 3.0V	All		0.001	10	μA	
DETECTO	R					1		
BV <sub>CEO</sub>	Breakdown Voltage	I <sub>C</sub> = 1.0mA, I <sub>F</sub> = 0	H11G1M	100			V	
	Collector to Emitter		H11G2M	80				
			H11G3M	55				
BV <sub>CBO</sub>	$I_{CBO}$ Collector to Base $I_{C} = 100 \mu A$	I <sub>C</sub> = 100μA	H11G1M	100			V	
			H11G2M	80				
			H11G3M	55				
BV <sub>EBO</sub>	Emitter to Base		All	7	10		V	
I <sub>CEO</sub>	Leakage Current	V <sub>CE</sub> = 80V, I <sub>F</sub> = 0	H11G1M			100	nA	
Collecto		Collector to Emitter	V <sub>CE</sub> = 60V, I <sub>F</sub> = 0	H11G2M				
			V <sub>CE</sub> = 30V, I <sub>F</sub> = 0	H11G3M				
		V <sub>CE</sub> = 80V, I <sub>F</sub> = 0, T <sub>A</sub> = 80°C	H11G1M			100	μA	
		V <sub>CE</sub> = 60V, I <sub>F</sub> = 0, T <sub>A</sub> = 80°C	H11G2M					

### **Transfer Characteristics**

Symbol	Characteristics	Test Conditions	Device	Min.	Тур.*	Max.	Units
EMITTER			1				
CTR	Current Transfer Ratio, Collector to Emitter	I <sub>F</sub> = 10mA, V <sub>CE</sub> = 1V	H11G1M/2M	100 (1000)			mA (%)
		I <sub>F</sub> = 1mA, V <sub>CE</sub> = 5V	H11G1M/2M	5 (500)			
Er			H11G3M	2 (200)			
V <sub>CE(SAT)</sub>	Saturation Voltage	I <sub>F</sub> = 16mA, I <sub>C</sub> = 50mA	H11G1M/2M		0.85	1.0	V
		I <sub>F</sub> = 1mA, I <sub>C</sub> = 1mA	H11G1M/2M		0.75	1.0	
		I <sub>F</sub> = 20mA, I <sub>C</sub> = 50mA	H11G3M		0.85	1.2	
SWITCHING	TIMES	•					
t <sub>ON</sub>	Turn-on Time	$R_{L} = 100\Omega, I_{F} = 10mA,$	All		5		μs
t <sub>OFF</sub>	Turn-off Time	V <sub>CE</sub> = 5V, f ≤ 30Hz, Pulse Width ≤ 300µs	All		100		μs

#### **Isolation Characteristics**

Symbol	Characteristic	Test Conditions	Device	Min.	Тур.*	Max.	Units
V <sub>ISO</sub>	Isolation Voltage	f = 60Hz, t = 1 sec.	All	7500			V <sub>AC</sub> PEAK
R <sub>ISO</sub>	Isolation Resistance	V <sub>I-O</sub> = 500 VDC	All	10 <sup>11</sup>			Ω
C <sub>ISO</sub>	Isolation Capacitance	f = 1MHz	All		0.2		pF

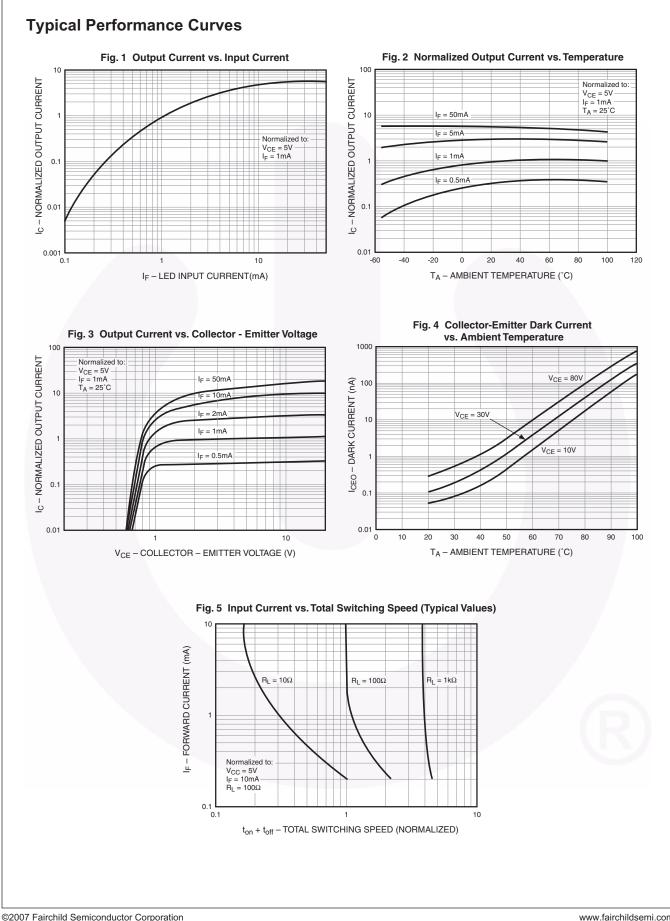
\*All Typical values at T<sub>A</sub> = 25°C

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## Safety and Insulation Ratings

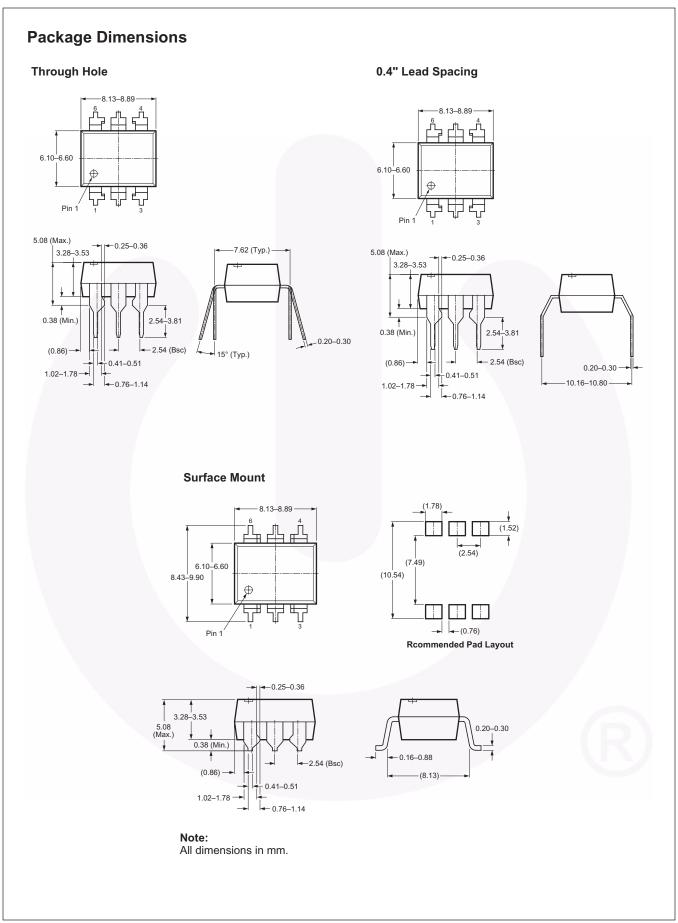
As per IEC 60747-5-2, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Symbol	Parameter	Min.	Тур.	Max.	Unit
	Installation Classifications per DIN VDE 0110/1.89 Table 1				
	For Rated Main Voltage < 150Vrms		I-IV		
	For Rated Main voltage < 300Vrms		I-IV		
	Climatic Classification		55/100/21		
	Pollution Degree (DIN VDE 0110/1.89)		2		
CTI	Comparative Tracking Index	175			
V <sub>PR</sub>	Input to Output Test Voltage, Method b, $V_{IORM} \times 1.875 = V_{PR}$ , 100% Production Test with tm = 1 sec, Partial Discharge < 5pC	1594			V <sub>peak</sub>
	Input to Output Test Voltage, Method a, $V_{IORM} \times 1.5 = V_{PR}$ , Type and Sample Test with tm = 60 sec, Partial Discharge < 5pC	1275			V <sub>peak</sub>
V <sub>IORM</sub>	Max. Working Insulation Voltage	850			V <sub>peak</sub>
V <sub>IOTM</sub>	Highest Allowable Over Voltage	6000			V <sub>peak</sub>
	External Creepage	7			mm
	External Clearance	7			mm
	Insulation Thickness	0.5			mm
RIO	Insulation Resistance at Ts, $V_{IO} = 500V$	10 <sup>9</sup>			Ω



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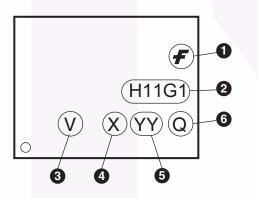


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## **Ordering Information**

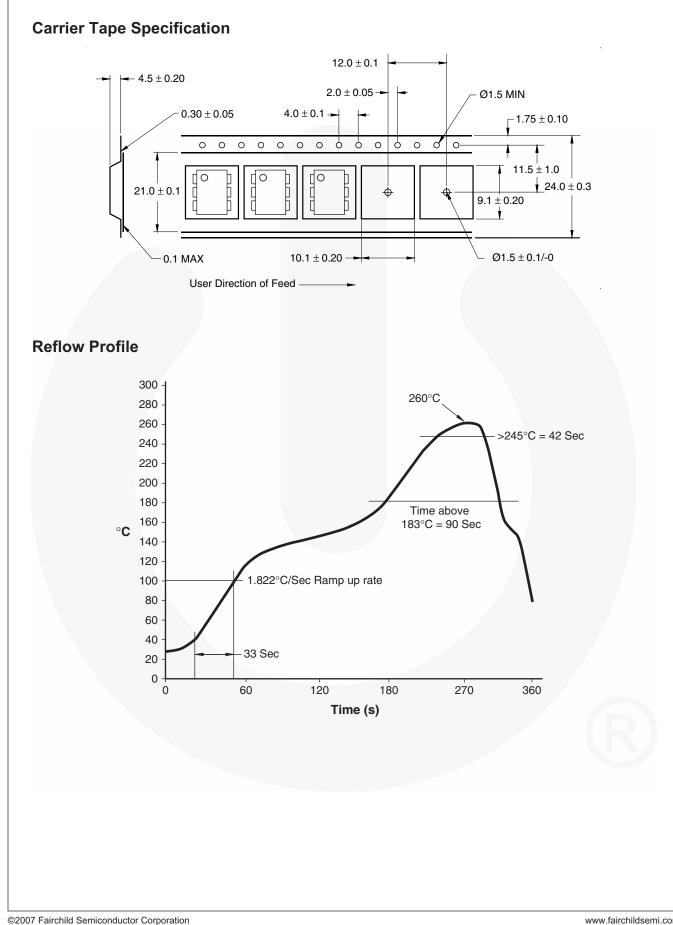
Option	Order Entry Identifier (Example)	Description
No option	H11G1M	Standard Through Hole Device
S	H11G1SM	Surface Mount Lead Bend
SR2	H11G1SR2M	Surface Mount; Tape and Reel
Т	H11G1TM	0.4" Lead Spacing
V	H11G1VM	VDE 0884
TV	H11G1TVM	VDE 0884, 0.4" Lead Spacing
SV	H11G1SVM	VDE 0884, Surface Mount
SR2V	H11G1SR2VM	VDE 0884, Surface Mount, Tape and Reel

## **Marking Information**

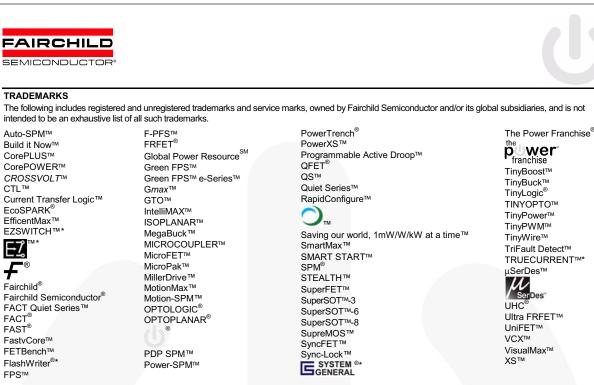


Definiti	ons
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code, e.g., '7'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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